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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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LOW-JITTER SAW OSCILLATOR (SPSO)
OUTPUT : CMOS

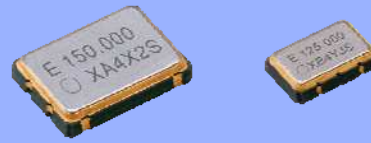
XG - 1000CA / CB

- Output frequency range : 50 MHz to 170 MHz
- Supply voltage : 1.8 V / 2.5 V / 3.3 V
- Frequency tolerance : $\pm 50 \times 10^{-6}$, $\pm 100 \times 10^{-6}$
- Output : CMOS
- Function : Output enable (OE)
- External dimensions : CA: 7.0×5.0×1.2 mm
CB: 5.0×3.2×1.1 mm

- Very low jitter and low phase noise by SAW unit.



Product Number (please contact us)
XG-1000CA: Q3851CA00xxxx00
XG-1000CB: Q3851CB00xxxx00



Actual size



Specifications (characteristics)

Item	Symbol	Specifications	Conditions / Remarks
Output frequency range *1	f _o	50.000 MHz to 170.000 MHz 75.000 MHz, 98.304 MHz, 100.000 MHz, 106.250 MHz, 125.000 MHz, 150.000 MHz	Standard frequency
Supply voltage	V _{cc}	E: 1.8 V ±0.1V D: 2.5 V ±0.125 V C: 3.3 V ±0.3V	
Storage temperature	T _{stg}	-40 °C to +100 °C	Storage as single product.
Operating temperature	T _{use}	-10°C to +70°C	
Frequency tolerance *2	f _{tol}	B: $\pm 50 \times 10^{-6}$ C: $\pm 100 \times 10^{-6}$	
Current consumption	I _{cc}	20 mA Max. 25 mA Max. 35 mA Max.	OE=V _{cc} , No load condition
Disable current	I _{dis}	15 mA Max. 20 mA Max. 30 mA Max.	OE=GND
Symmetry	SYM	40 % to 60 % 45 % to 55 %	f _o ≤ 125 MHz 50 % V _{cc} level, L _{CMOS} ≤ Max.
Output voltage	V _{OH}	V _{cc} -0.35 V Min.	E: I _{OH} = -6 mA / C, D: I _{OH} = -8 mA
	V _{OL}	0.35 V Max.	E: I _{OL} = 6 mA / C, D: I _{OL} = 8 mA
Output load condition (CMOS)	L _{CMOS}	15 pF Max.	
Input voltage	V _{IH}	70 % V _{cc} Min.	
	V _{IL}	30 % V _{cc} Max.	OE terminal
Rise time / Fall time	t _r / t _f	2 ns Max.	Between 20% V _{cc} and 80% V _{cc} level, L _{CMOS} ≤ Max
Start-up time	t _{str}	10 ms Max.	Time at minimum supply voltage to be 0 s
Jitter *3	t _{RMS}	3 ps Typ.	σ (RMS of total distribution)
	t _{p-p}	25 ps Typ.	Peak to Peak
Frequency aging	f _{aging}	$\pm 5 \times 10^{-6}$ / year Max.	+25 °C, First year, V _{cc} =1.8 V, 2.5 V, 3.3 V

*1 Please contact us for requirements non-standard frequencies.
*2 This includes initial frequency tolerance, temperature variation, supply voltage variation and load variation.
*3 Tested using a DTS-2075 Digital timing system made by WAVECREST with jitter analysis software VISI6.

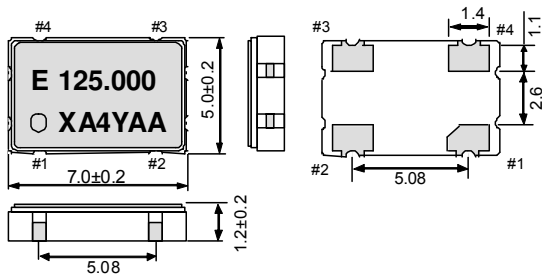
Product Name XG-1000 CA 150.000000MHz D B
(Standard form) ① ② ③ ④ ⑤
① Model ② Package type ③ Frequency
④ Supply voltage
⑤ Frequency tolerance / Operating temperature

④ Supply voltage	⑤ Frequency tolerance
C 3.3 V Typ.	B $\pm 50 \times 10^{-6}$ / -10 to +70°C
D 2.5 V Typ.	C $\pm 100 \times 10^{-6}$ / -10 to +70°C
E 1.8 V Typ.	

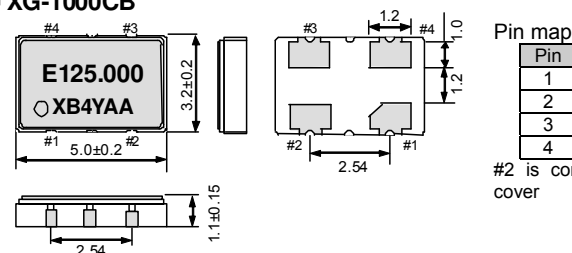
External dimensions

(Unit:mm)

● XG-1000CA



● XG-1000CB



Pin map

Pin	Connection
1	OE
2	GND
3	OUT
4	V _{cc}

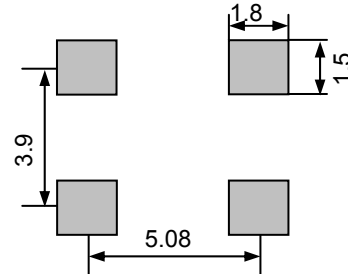
#2 is connected to the cover

OE pin = HIGH : Specified frequency output.
OE pin = LOW : Output is high impedance

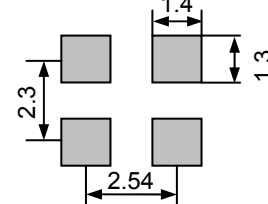
Footprint (Recommended)

(Unit:mm)

● XG-1000CA



● XG-1000CB



To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V_{cc} - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.





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In order provide high quality and reliable products and services than meet customer needs,

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ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.)

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